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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: K. TSUBOSAKI et al.  
Serial No.: 09/308,620  
Filed: May 20, 1999  
For: SEMICONDUCTOR DEVICE AND MANUFACTURING  
METHOD THEREOF

PRELIMINARY AMENDMENT

Assistant Commissioner for Patents  
Washington, D.C. 20231

August 18, 1999

Sir:

Prior to examination, please amend the above-identified  
application as follows:

IN THE SPECIFICATION

Page 1, line 4, delete in its entirety insert -- BACKGROUND  
OF THE INVENTION --;

*Entered  
in - part*

line 6, after "and" insert -- the --;  
line 7, delete the comma insert a semicolon, after  
"and" insert a comma, after "particularly" insert  
-- , the invention relates --;

line 11, delete in its entirety;

line 13, delete "less in" insert -- , of reduced --,  
after "thickness" insert a comma;

line 14, after "functionalities" insert a comma,  
after "is" insert -- being --;

line 16, delete "important", after "more" insert  
-- important --;

line 17, delete "such";

TC 2800 1999  
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